International Rectifier

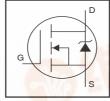
AUTOMOTIVE GRADE

PD - 97460

AUIRF1404Z AUIRF1404ZS AUIRF1404ZL

Features

- Advanced Process Technology
- Low On-Resistance
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified *

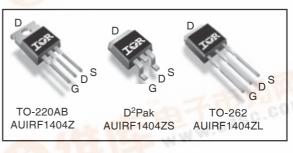


$V_{(BR)DSS}$ 40V $R_{DS(on)}$ max. 3.7mΩ $I_{D \text{ (Silicon Limited)}}$ 180A \bullet 1 $I_{D \text{ (Package Limited)}}$ 160A

HEXFET® Power MOSFET

Description

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



G	D	S
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	1800	50-
I _D @ T _C = 100°C	Continuous Drain Current, VGS @ 10V (Silicon Limited)	120	Α
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Package Limited)	160	
I _{DM}	Pulsed Drain Current ①	710	
P _D @T _C = 25°C	Power Dissipation	200	W
	Linear Derating Factor	1.3	W/°C
V _{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) ②	330	mJ
E _{AS} (tested)	Single Pulse Avalanche Energy Tested Value ©	480	-T. W
I _{AR}	Avalanche Current ①	See Fig.12a, 12b, 15, 16	Α
E _{AR}	Repetitive Avalanche Energy ©	一用丁	mJ
T _J	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range	1-1-1	°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	
	Mounting Torque, 6-32 or M3 screw ⑦	10 lbf•in (1.1N•m)	

Thermal Resistance

The mai he sistance							
	Parameter	Тур.	Max.	Units			
R _{θJC}	Junction-to-Case ®		0.75 9	°C/W			
R _{θCS}	Case-to-Sink, Flat Greased Surface ⑦	0.50					
$R_{\theta JA}$	Junction-to-Ambient ⑦		62				
$R_{\theta JA}$	Junction-to-Ambient (PCB Mount) ®		40	[

HEXFET® is a registered trademark of International Rectifier.
*Qualification standards can be found at http://www.irf.com/

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	40			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.033		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		2.7	3.7	mΩ	V _{GS} = 10V, I _D = 75A ③
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
gfs	Forward Transconductance	170			V	$V_{DS} = 25V, I_D = 75A$
I _{DSS}	Drain-to-Source Leakage Current			20		$V_{DS} = 40V, V_{GS} = 0V$
				250		$V_{DS} = 40V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			200	nA	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-200		$V_{GS} = -20V$

Dynamic Electrical @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_g	Total Gate Charge		100	150		I _D = 75A
Q_{gs}	Gate-to-Source Charge		31		nC	$V_{DS} = 32V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		42		ĺ	V _{GS} = 10V ③
t _{d(on)}	Turn-On Delay Time		18			$V_{DD} = 20V$
t _r	Rise Time		110		1	$I_D = 75A$
t _{d(off)}	Turn-Off Delay Time		36		ns	$R_G = 3.0 \Omega$
t _f	Fall Time		58		1	V _{GS} = 10V ③
L _D	Internal Drain Inductance		4.5			Between lead,
					nН	6mm (0.25in.)
L _S	Internal Source Inductance		7.5		1	from package
						and center of die contact
C _{iss}	Input Capacitance		4340			$V_{GS} = 0V$
C _{oss}	Output Capacitance		1030	_	1	$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		550		рF	f = 1.0MHz
Coss	Output Capacitance		3300		1	$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
C _{oss}	Output Capacitance	_	920		1	$V_{GS} = 0V, V_{DS} = 32V, f = 1.0MHz$
C _{oss} eff.	Effective Output Capacitance		1350		1	$V_{GS} = 0V$, $V_{DS} = 0V$ to 32V $\textcircled{4}$

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			160		MOSFET symbol
	(Body Diode)				Α	showing the
I _{SM}	Pulsed Source Current			750		integral reverse
	(Body Diode) ①					p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C$, $I_S = 75A$, $V_{GS} = 0V$ ③
t _{rr}	Reverse Recovery Time		28	42	ns	$T_J = 25^{\circ}C, I_F = 75A, V_{DD} = 20V$
Q _{rr}	Reverse Recovery Charge		34	51	nC	di/dt = 100A/µs ③
t _{on}	Forward Turn-On Time	Intrinsio	turn-or	time is	negligib	le (turn-on is dominated by LS+LD)

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- ② Limited by T_{Jmax} , starting $T_J = 25^{\circ}C$, L = 0.11mH $R_G = 25\Omega$, $I_{AS} = 75A$, $V_{GS} = 10V$. Part not recommended for use above this value.
- $\ \, \mbox{$ \oplus$} \, \, C_{oss}$ eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .
- S Limited by T_{Jmax}, see Fig.12a, 12b, 15, 16 for typical repetitive avalanche performance.
- ® This value is determined from sample failure population, starting $T_J = 25^{\circ}C$, L = 0.11mH, $R_G = 25\Omega$, $I_{AS} = 75A$, $V_{GS} = 10V$.

- This is only applied to TO-220AB pakcage.
- This is applied to D²Pak, when mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994.
- 9 TO-220 device will have an Rth value of 0.65°C/W.
- \bigcirc R_{θ} is measured at T_J approximately 90°C.
- Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 160A. Note that current limitations arising from heating of the device leads may occur with some lead mounting arrangements.(Refer to AN-1140) http://www.irf.com/technical-info/appnotes/an-1140.pdf

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Qualification Information[†]

Qualification L	.evel	Automotive (per AEC-Q101) †† Comments: This part number(s) passed Automotive qualificatio IR's Industrial and Consumer qualification level is granted I extension of the higher Automotive level.			
		TO-220AB	N/A		
Moisture Sens	itivity Level	TO-262	N/A		
		D ² PAK	MSL1		
	Machine Model	Class M4			
		AEC-Q101-002			
500	Human Body Model	Class H1C			
ESD			AEC-Q101-001		
	Charged Device Model		Class C3		
		AEC-Q101-005			
RoHS Complia	int		Yes		

- † Qualification standards can be found at International Rectifier's web site: http://www.irf.com/
- †† Exceptions to AEC-Q101 requirements are noted in the qualification report.

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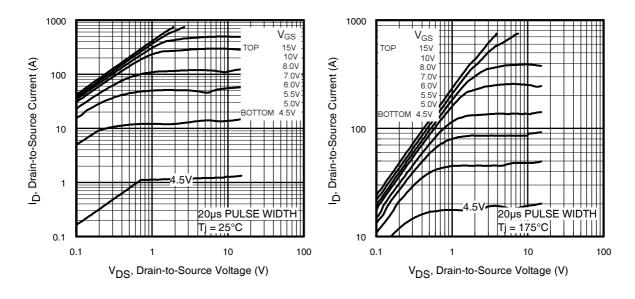


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics

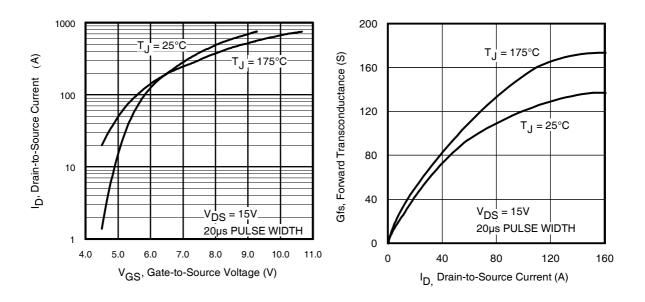


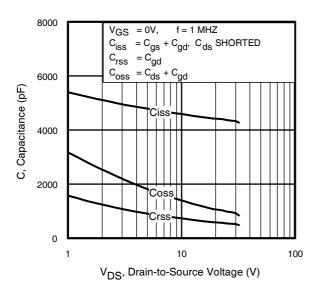
Fig 3. Typical Transfer Characteristics

Fig 4. Typical Forward Transconductance Vs. Drain Current

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AUIRF1404Z/S/L



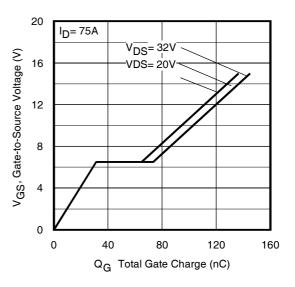
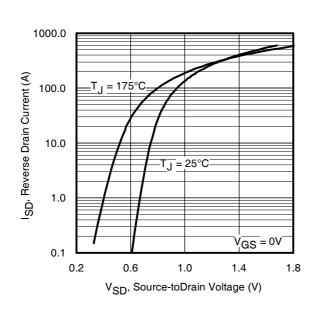


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage



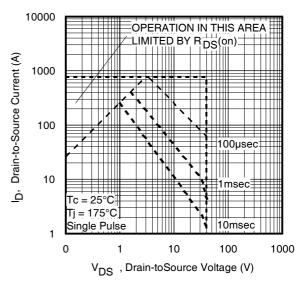


Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

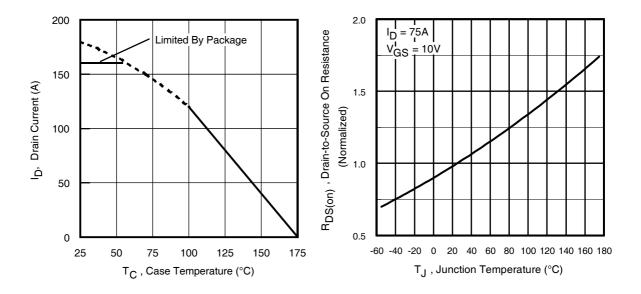


Fig 9. Maximum Drain Current Vs. Case Temperature

Fig 10. Normalized On-Resistance Vs. Temperature

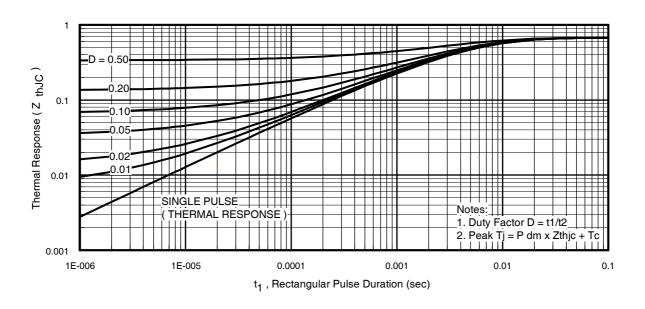


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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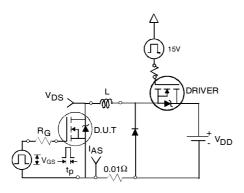


Fig 12a. Unclamped Inductive Test Circuit

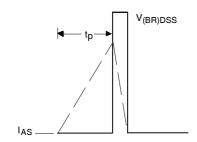


Fig 12b. Unclamped Inductive Waveforms

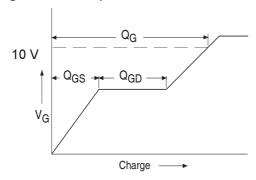


Fig 13a. Basic Gate Charge Waveform

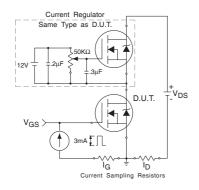


Fig 13b. Gate Charge Test Circuit www.irf.com

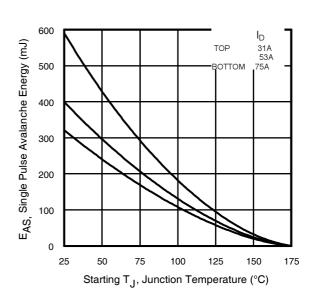


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

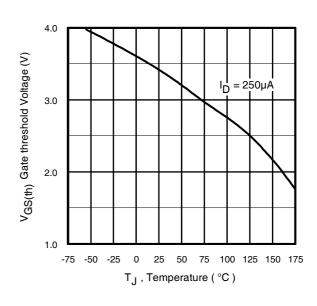


Fig 14. Threshold Voltage Vs. Temperature

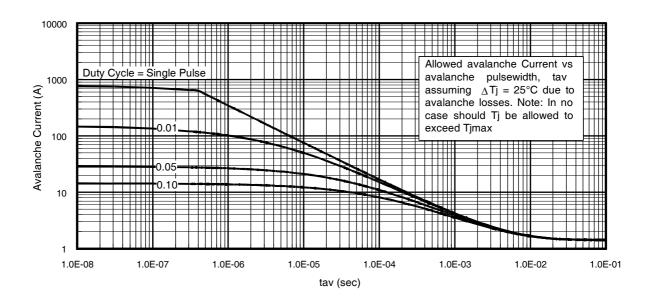


Fig 15. Typical Avalanche Current Vs. Pulsewidth

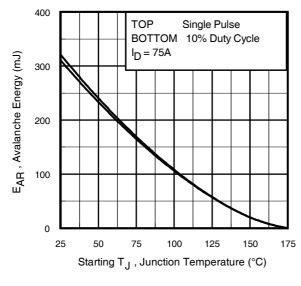


Fig 16. Maximum Avalanche Energy Vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 15, 16: (For further info, see AN-1005 at www.irf.com)

- 1. Avalanche failures assumption:
 - Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax} . This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long asT_{jmax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 12a, 12b.
- 4. $P_{D (ave)}$ = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 15, 16).

 t_{av} = Average time in avalanche. D = Duty cycle in avalanche = $t_{av} \cdot f$

 $Z_{thJC}(D, t_{av})$ = Transient thermal resistance, see figure 11)

$$\begin{split} P_{D \; (ave)} = 1/2 \; (\; 1.3 \cdot BV \cdot I_{av}) = \triangle T / \; Z_{thJC} \\ I_{av} = 2 \triangle T / \; [1.3 \cdot BV \cdot Z_{th}] \end{split}$$
E_{AS (AR)} = P_{D (ave)}·t_{av}

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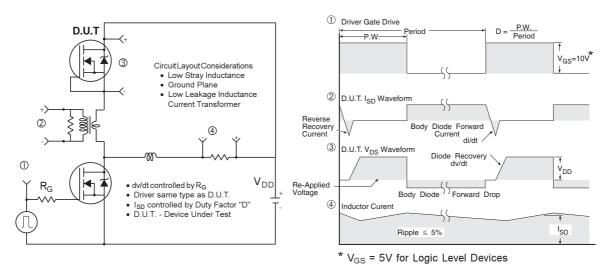


Fig 17. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

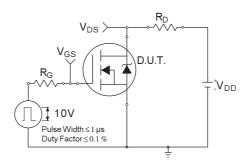


Fig 18a. Switching Time Test Circuit

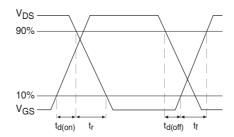


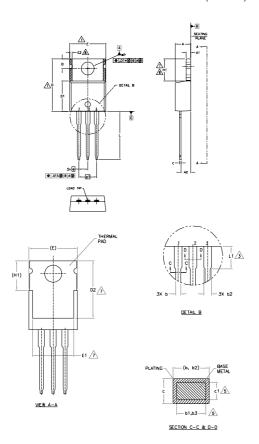
Fig 18b. Switching Time Waveforms

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TO-220AB Package Outline

Dimensions are shown in millimeters (inches)

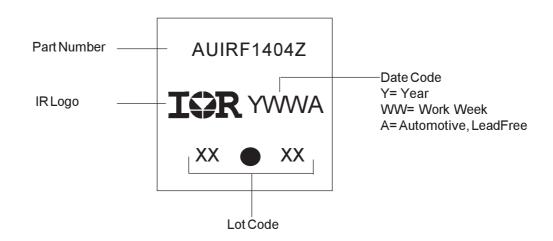


IDTES:

- 1.- DIMENSIONING AND TOLERANCING AS PER ASME Y14.5 M- 1994
- UMENSIONS ARE SHOWN IN INCHES [MILLIMETERS].
 IFAD DIMENSION AND FINISH UNCONTROLLED IN LI
- DIMENSION D, D1 & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH
 SHALL NOT EXCEED .005" (0.127) PER SIDE, THESE DIMENSIONS AR
 MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- DIMENSION 61, 63 & c1 APPLY 15 BASE WETAL ONLY.
- 7.— THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E. R.— DIMENSION E2 X H1 DEFINE & ZONE WHERE STAMPING.
- B. DIMENSION, EZ X H1 DEFINE A ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED.
- OUTLINE CONFORMS TO JEDEC 10-220, EXCEPT A2 (mox.) AND D2 (min WHERE DIMENSIONS ARE DERIVED FROM THE ACTUAL PACKAGE OUTLINE.

SYMBOL	MILLIM	ETERS	INC	INCHES		
l	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	3,56	4.83	,140	.190		
A1	0.51	1.40	.020	.055		
A2	2.03	2.92	.080	.115		
ь	0.38	1.01	.015	.040		
ь1	0.38	0.97	.015	.038	5	
b2	1,14	1.78	.045	.070		
b3	1,14	1,73	.045	.068	5	
С	0.36	0.61	.014	.024		
c1	0.36	0.56	.014	.022	5	
D	14.22	16.51	.560	.650	4	
D1	8.38	9.02	.330	,355		
D2	11.68	12.88	.460	.507	7	
E	9.65	10,67	.380	.420	4,7	
E1	6.86	8,89	.270	.350	7	
E2	-	0.76	-	.030	8	
e	2.54		.100			
e1	5.08	BSC	.200	BSC		
H1	5.84	6.86	.230	.270	7,8	
L	12.70	14.73	.500	.580		
L1	3.56	4,06	.140	.160	3	
øP	3.54	4.08	.139	.161		
0	2.54	3.42	.100	.135		

TO-220AB Part Marking Information



TO-220AB packages are not recommended for Surface Mount Application.

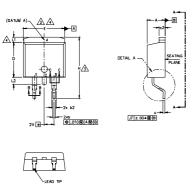
Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

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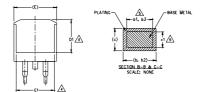
AUIRF1404Z/S/L

D²Pak (TO-263AB) Package Outline

Dimensions are shown in millimeters (inches)



LEAD TIP	
GALICE PLANE 0'-6' DETAIL 'A' ROTATE 9C ON SCALE 6:1	B SEATING PLANE



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S Y M B O L			Ŋ		
B	MILLIM	ETERS	INC	HES	O T E S
Ľ	MIN.	MAX.	MIN.	MAX.	S
Α	4.06	4.83	.160	.190	
A1	0.00	0.254	.000	.010	
ь	0.51	0.99	.020	.039	
ь1	0.51	0.89	.020	.035	5
b2	1,14	1,78	.045	.070	
ь3	1,14	1,73	.045	.068	5
С	0.38	0.74	.015	.029	
c1	0.38	0.58	.015	.023	5
c2	1,14	1,65	.045	.065	
D	8.38	9.65	.330	.380	3
D1	6.86	-	.270		4
E	9.65	10.67	.380	.420	3,4
E1	6.22	-	.245		4
e	2.54	BSC	.100	BSC	
н	14.61	15.88	.575	.625	
L	1.78	2.79	.070	.110	
L1	-	1,65	-	.066	4
L2	-	1,78	- ,070		
L3	0.25	BSC	.010	BSC	
L4	4,78	5.28	.188	.208	

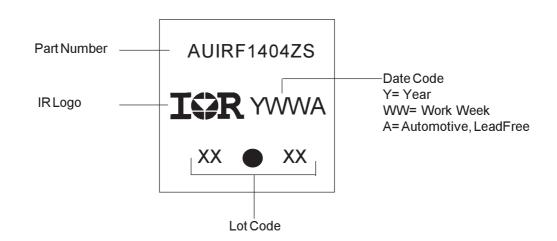
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED

 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.

11

- THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
- 5. DIWENSION 61 AND 61 APPLY TO BASE METAL ONLY.
- 6. DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- 7. CONTROLLING DIMENSION: INCH.
- 8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-263AB

D²Pak (TO-263AB) Part Marking Information



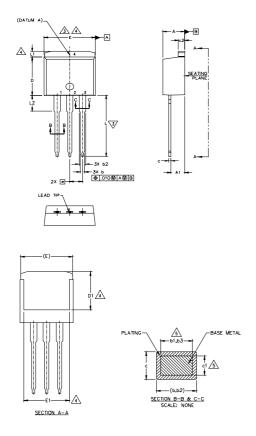
Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

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TO-262 Package Outline

Dimensions are shown in millimeters (inches)



S Y M		DIMENSIONS				
B	MILLIM	ETERS	TERS INCH		N OT ES	
B 0 L	MIN.	MAX.	MIN.	MAX.	S	
Α	4.06	4.83	.160	.190		
Α1	2.03	3.02	.080	.119		
ь	0.51	0.99	.020	.039		
ь1	0.51	0.89	.020	.035	5	
ь2	1,14	1.78	.045	.070		
ь3	1.14	1.73	.045	.068	5	
С	0.38	0.74	.015	.029		
c1	0.38	0.58	.015	.023	5	
c2	1.14	1.65	.045	.065		
D	8.38	9.65	.330	.380	3	
D1	6.86	-	.270	_	4	
E	9.65	10.67	.380	.420	3,4	
E1	6.22	-	.245		4	
е	2.54	BSC	.100 BSC			
L	13.46	14.10	.530	.555		
L1	_	1.65	_	.065	4	
L2	3.56	3.71	.140	.146		

MOTES,

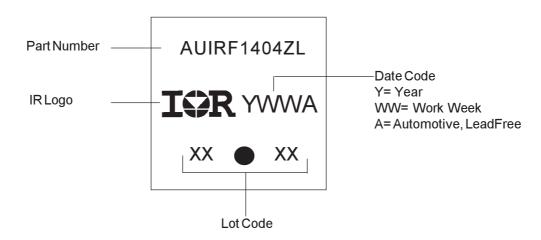
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2. DIRECTION AND TOLERANDAM FOR ASILE TRANS-1998

2. DIRECTION AND THE ASILE TRANS-1998

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TO-262 Part Marking Information



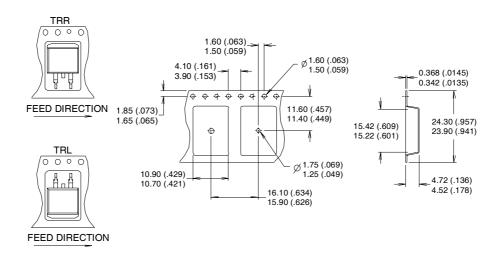
Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

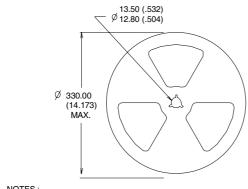
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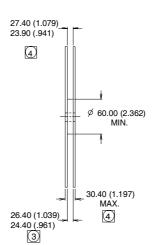
AUIRF1404Z/S/L

D²Pak Tape & Reel Information

Dimensions are shown in millimeters (inches)







NOTES:

- DIES: COMFORMS TO EIA-418. CONTROLLING DIMENSION: MILLIMETER. DIMENSION MEASURED @ HUB. INCLUDES FLANGE DISTORTION @ OUTER EDGE.

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Base part number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRF1404Z	TO-220	Tube	50	AUIRF1404Z
AUIRF1404ZL	TO-262	Tube	50	AUIRF1404ZL
AUIRF1404ZS	D2Pak	Tube	50	AUIRF1404ZS
		Tape and Reel Left	800	AUIRF1404ZSTRL
		Tape and Reel Right	800	AUIRF1404ZSTRR
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International

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AUIRF1404Z/S/L

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